

2.5V LVDS 1:6 CLOCK BUFFER TERABUFFER™ II

IDT5T9306

FEATURES:

- Guaranteed Low Skew < 25ps (max)
- Very low duty cycle distortion < 125ps (max)
- High speed propagation delay < 1.75ns (max)
- Additive phase jitter, RMS 0.159ps (typical) @ 125MHz
- Up to 1GHz operation
- Selectable inputs
- Hot insertable and over-voltage tolerant inputs
- 3.3V / 2.5V LVTTTL, HSTL, eHSTL, LVEPECL (2.5V), LVPECL (3.3V), CML, or LVDS input interface
- Selectable differential inputs to six LVDS outputs
- Power-down mode
- 2.5V V_{DD}
- Available in VFQFPN package

APPLICATIONS:

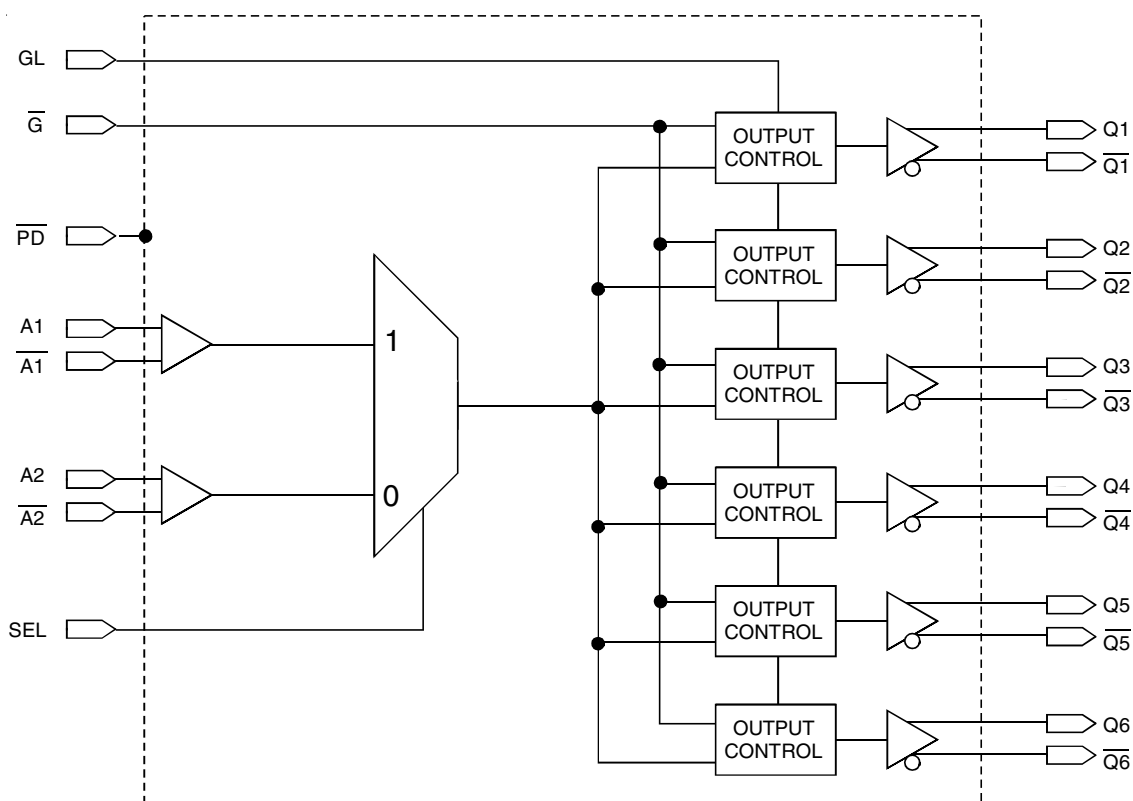
- Clock distribution

DESCRIPTION:

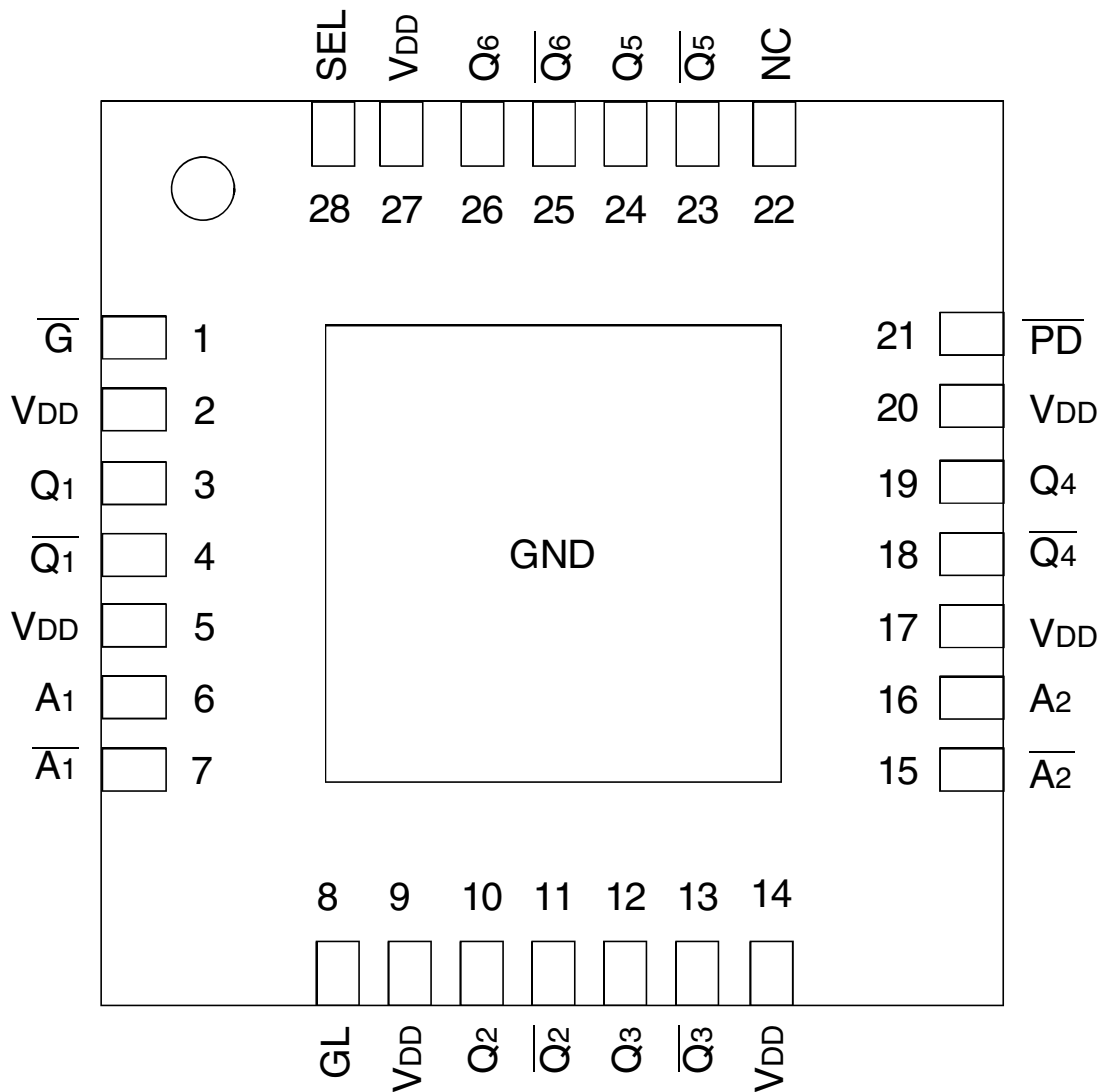
The IDT5T9306 2.5V differential clock buffer is a user-selectable differential input to six LVDS outputs. The fanout from a differential input to six LVDS outputs reduces loading on the preceding driver and provides an efficient clock distribution network. The IDT5T9306 can act as a translator from a differential HSTL, eHSTL, LVEPECL (2.5V), LVPECL (3.3V), CML, or LVDS input to LVDS outputs. A single-ended 3.3V / 2.5V LVTTTL input can also be used to translate to LVDS outputs. The redundant input capability allows for an asynchronous change-over from a primary clock source to a secondary clock source. Selectable reference inputs are controlled by SEL.

The IDT5T9306 outputs can be asynchronously enabled/disabled. When disabled, the outputs will drive to the value selected by the GL pin. Multiple power and grounds reduce noise.

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATION



VFQFPN
TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
V _{DD}	Power Supply Voltage	−0.5 to +3.6	V
V _I	Input Voltage	−0.5 to +3.6	V
V _O	Output Voltage ⁽²⁾	−0.5 to V _{DD} +0.5	V
T _{STG}	Storage Temperature	−65 to +150	°C
T _J	Junction Temperature	150	°C

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- Not to exceed 3.6V.

CAPACITANCE⁽¹⁾ (T_A = +25°C, F = 1.0MHz)

Symbol	Parameter	Min	Typ.	Max.	Unit
C _{IN}	Input Capacitance	—	—	3	pF

NOTE:

- This parameter is measured at characterization but not tested

RECOMMENDED OPERATING RANGE

Symbol	Description	Min.	Typ.	Max.	Unit
T _A	Ambient Operating Temperature	−40	+25	+85	°C
V _{DD}	Internal Power Supply Voltage	2.3	2.5	2.7	V

PIN DESCRIPTION

Symbol	I/O	Type	Description
A _[1:2]	I	Adjustable ^(1,4)	Clock input. A _[1:2] is the "true" side of the differential clock input.
A _[1:2]	I	Adjustable ^(1,4)	Complementary clock inputs. A _[1:2] is the complementary side of A _[1:2] . For LVTTTL single-ended operation, A _[1:2] should be set to the desired toggle voltage for A _[1:2] : 3.3V LVTTTL V _{REF} = 1650mV 2.5V LVTTTL V _{REF} = 1250mV
G	I	LVTTTL	Gate control for differential outputs Q ₁ and Q ₁ through Q ₆ and Q ₆ . When G is LOW, the differential outputs are active. When G is HIGH, the differential outputs are asynchronously driven to the level designated by GL ⁽²⁾ .
GL	I	LVTTTL	Specifies output disable level. If HIGH, "true" outputs disable HIGH and "complementary" outputs disable LOW. If LOW, "true" outputs disable LOW and "complementary" outputs disable HIGH.
Q _n	O	LVDS	Clock outputs
Q _n	O	LVDS	Complementary clock outputs
SEL	I	LVTTTL	Reference clock select. When LOW, selects A ₂ and A ₂ . When HIGH, selects A ₁ and A ₁ .
PD	I	LVTTTL	Power-down control. Shuts off entire chip. If LOW, the device goes into low power mode. Inputs and outputs are disabled. Both "true" and "complementary" outputs will pull to V _{DD} . Set HIGH for normal operation. ⁽³⁾
V _{DD}		PWR	Power supply for the device core and inputs
GND		PWR	Power supply return for all power
NC			No connect; recommended to connect to GND

NOTES:

- Inputs are capable of translating the following interface standards:
Single-ended 3.3V and 2.5V LVTTTL levels
Differential HSTL and eHSTL levels
Differential LVEPECL (2.5V) and LVPECL (3.3V) levels
Differential LVDS levels
Differential CML levels
- Because the gate controls are asynchronous, runt pulses are possible. It is the user's responsibility to either time the gate control signals to minimize the possibility of runt pulses or be able to tolerate them in down stream circuitry.
- It is recommended that the outputs be disabled before entering power-down mode. It is also recommended that the outputs remain disabled until the device completes power-up after asserting PD.
- The user must take precautions with any differential input interface standard being used in order to prevent instability when there is no input signal.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE FOR LVTTTL⁽¹⁾

Symbol	Parameter	Test Conditions	Min.	Typ. ⁽²⁾	Max	Unit
Input Characteristics						
I _{IH}	Input HIGH Current	V _{DD} = 2.7V	—	—	±5	μA
I _{IL}	Input LOW Current	V _{DD} = 2.7V	—	—	±5	
V _{IK}	Clamp Diode Voltage	V _{DD} = 2.3V, I _{IN} = -18mA	—	-0.7	-1.2	V
V _{IN}	DC Input Voltage		-0.3	—	+3.6	V
V _{IH}	DC Input HIGH		1.7	—	—	V
V _{IL}	DC Input LOW		—	—	0.7	V
V _{THI}	DC Input Threshold Crossing Voltage		—	V _{DD} /2	—	V
V _{REF}	Single-Ended Reference Voltage ⁽³⁾	3.3VLVTTL	—	1.65	—	V
		2.5VLVTTL	—	1.25	—	

NOTES:

1. See RECOMMENDED OPERATING RANGE table.
2. Typical values are at V_{DD} = 2.5V, +25°C ambient.
3. For A_[1:2] single-ended operation, A_[1:2] is tied to a DC reference voltage.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE FOR DIFFERENTIAL INPUTS⁽¹⁾

Symbol	Parameter	Test Conditions	Min.	Typ. ⁽²⁾	Max	Unit
Input Characteristics						
I _{IH}	Input HIGH Current	V _{DD} = 2.7V	—	—	±5	μA
I _{IL}	Input LOW Current	V _{DD} = 2.7V	—	—	±5	
V _{IK}	Clamp Diode Voltage	V _{DD} = 2.3V, I _{IN} = -18mA	—	-0.7	-1.2	V
V _{IN}	DC Input Voltage		-0.3	—	+3.6	V
V _{DIF}	DC Differential Voltage ⁽³⁾		0.1	—	—	V
V _{CM}	DC Common Mode Input Voltage ⁽⁴⁾		0.05	—	V _{DD}	V

NOTES:

1. See RECOMMENDED OPERATING RANGE table.
2. Typical values are at V_{DD} = 2.5V, +25°C ambient.
3. V_{DIF} specifies the minimum input differential voltage (V_{TR} - V_{CP}) required for switching where V_{TR} is the "true" input level and V_{CP} is the "complement" input level. The DC differential voltage must be maintained to guarantee retaining the existing HIGH or LOW input. The AC differential voltage must be achieved to guarantee switching to a new state.
4. V_{CM} specifies the maximum allowable range of (V_{TR} + V_{CP}) /2.

DC ELECTRICAL CHARACTERISTICS OVER RECOMMENDED OPERATING RANGE FOR LVDS⁽¹⁾

Symbol	Parameter	Test Conditions	Min.	Typ. ⁽²⁾	Max	Unit
Output Characteristics						
V _{OT(+)}	Differential Output Voltage for the True Binary State		247	—	454	mV
V _{OT(-)}	Differential Output Voltage for the False Binary State		247	—	454	mV
ΔV _{OT}	Change in V _{OT} Between Complementary Output States		—	—	50	mV
V _{OS}	Output Common Mode Voltage (Offset Voltage)		1.125	1.2	1.375	V
ΔV _{OS}	Change in V _{OS} Between Complementary Output States		—	—	50	mV
I _{OS}	Outputs Short Circuit Current	V _{OUT +} and V _{OUT -} = 0V	—	12	24	mA
I _{OSD}	Differential Outputs Short Circuit Current	V _{OUT +} = V _{OUT -}	—	6	12	mA

NOTES:

1. See RECOMMENDED OPERATING RANGE table.
2. Typical values are at V_{DD} = 2.5V, T_A = +25°C ambient.

DIFFERENTIAL INPUT AC TEST CONDITIONS FOR HSTL

Symbol	Parameter	Value	Units
V _{DIF}	Input Signal Swing ⁽¹⁾	1	V
V _X	Differential Input Signal Crossing Point ⁽²⁾	750	mV
D _H	Duty Cycle	50	%
V _{THI}	Input Timing Measurement Reference Level ⁽³⁾	Crossing Point	V
t _R , t _F	Input Signal Edge Rate ⁽⁴⁾	2	V/ns

NOTES:

1. The 1V peak-to-peak input pulse level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. This device meets the V_{DIF} (AC) specification under actual use conditions.
2. A 750mV crossing point level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. This device meets the V_X specification under actual use conditions.
3. In all cases, input waveform timing is marked at the differential cross-point of the input signals.
4. The input signal edge rate of 2V/ns or greater is to be maintained in the 20% to 80% range of the input waveform.

DIFFERENTIAL INPUT AC TEST CONDITIONS FOR eHSTL

Symbol	Parameter	Value	Units
V _{DIF}	Input Signal Swing ⁽¹⁾	1	V
V _X	Differential Input Signal Crossing Point ⁽²⁾	900	mV
D _H	Duty Cycle	50	%
V _{THI}	Input Timing Measurement Reference Level ⁽³⁾	Crossing Point	V
t _R , t _F	Input Signal Edge Rate ⁽⁴⁾	2	V/ns

NOTES:

1. The 1V peak-to-peak input pulse level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. This device meets the V_{DIF} (AC) specification under actual use conditions.
2. A 900mV crossing point level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. This device meets the V_X specification under actual use conditions.
3. In all cases, input waveform timing is marked at the differential cross-point of the input signals.
4. The input signal edge rate of 2V/ns or greater is to be maintained in the 20% to 80% range of the input waveform.

DIFFERENTIAL INPUT AC TEST CONDITIONS FOR LVEPECL (2.5V) AND LVPECL (3.3V)

Symbol	Parameter	Value	Units
V _{DIF}	Input Signal Swing ⁽¹⁾	732	mV
V _X	Differential Input Signal Crossing Point ⁽²⁾	LVEPECL	mV
		LVPECL	
D _H	Duty Cycle	50	%
V _{THI}	Input Timing Measurement Reference Level ⁽³⁾	Crossing Point	V
t _R , t _F	Input Signal Edge Rate ⁽⁴⁾	2	V/ns

NOTES:

1. The 732mV peak-to-peak input pulse level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. This device meets the V_{DIF} (AC) specification under actual use conditions.
2. 1082mV LVEPECL (2.5V) and 1880mV LVPECL (3.3V) crossing point levels are specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. This device meets the V_X specification under actual use conditions.
3. In all cases, input waveform timing is marked at the differential cross-point of the input signals.
4. The input signal edge rate of 2V/ns or greater is to be maintained in the 20% to 80% range of the input waveform.

DIFFERENTIAL INPUT AC TEST CONDITIONS FOR LVDS

Symbol	Parameter	Value	Units
V _{DIF}	Input Signal Swing ⁽¹⁾	400	mV
V _X	Differential Input Signal Crossing Point ⁽²⁾	1.2	V
D _H	Duty Cycle	50	%
V _{THI}	Input Timing Measurement Reference Level ⁽³⁾	Crossing Point	V
t _R , t _F	Input Signal Edge Rate ⁽⁴⁾	2	V/ns

NOTES:

1. The 400mV peak-to-peak input pulse level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. This device meets the V_{DIF} (AC) specification under actual use conditions.
2. A 1.2V crossing point level is specified to allow consistent, repeatable results in an automatic test equipment (ATE) environment. This device meets the V_X specification under actual use conditions.
3. In all cases, input waveform timing is marked at the differential cross-point of the input signals.
4. The input signal edge rate of 2V/ns or greater is to be maintained in the 20% to 80% range of the input waveform.

AC DIFFERENTIAL INPUT SPECIFICATIONS⁽¹⁾

Symbol	Parameter	Min.	Typ.	Max	Unit
V _{DIF}	AC Differential Voltage ⁽²⁾	0.1	—	3.6	V
V _{IX}	Differential Input Crosspoint Voltage	0.05	—	V _{DD}	V
V _{CM}	Common Mode Input Voltage Range ⁽³⁾	0.05	—	V _{DD}	V
V _{IN}	Input Voltage	-0.3		+3.6	V

NOTES:

1. The output will not change state until the inputs have crossed and the minimum differential voltage range defined by V_{DIF} has been met or exceeded.
2. V_{DIF} specifies the minimum input voltage (V_{TR} - V_{CP}) required for switching where V_{TR} is the "true" input level and V_{CP} is the "complement" input level. The AC differential voltage must be achieved to guarantee switching to a new state.
3. V_{CM} specifies the maximum allowable range of (V_{TR} + V_{CP}) /2.

POWER SUPPLY CHARACTERISTICS FOR LVDS OUTPUTS⁽¹⁾

Symbol	Parameter	Test Conditions	Typ.	Max	Unit
I _{DDQ}	Quiescent V _{DD} Power Supply Current	V _{DD} = Max., All Input Clocks = LOW ⁽²⁾ Outputs enabled	—	240	mA
I _{TOT}	Total Power V _{DD} Supply Current	V _{DD} = 2.7V., F _{REFERENCE CLOCK} = 1GHz	—	250	mA
I _{PD}	Total Power Down Supply Current	PD = LOW	—	5	mA

NOTES:

1. These power consumption characteristics are for all the valid input interfaces and cover the worst case conditions.
2. The true input is held LOW and the complementary input is held HIGH.

AC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE^(1,5)

Symbol	Parameter	Min.	Typ.	Max	Unit
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Skew Parameters

$t_{sk(o)}$	Same Device Output Pin-to-Pin Skew ⁽²⁾	—	—	25	ps
$t_{sk(p)}$	Pulse Skew ⁽³⁾	—	—	125	ps
$t_{sk(pp)}$	Part-to-Part Skew ⁽⁴⁾	—	—	300	ps

Propagation Delay

t_{PLH} t_{PHL}	Propagation Delay A, A Crosspoint to Qn, Qn Crosspoint	—	1.25	1.75	ns
f_o	Frequency Range ⁽⁶⁾	—	—	1	GHz

Output Gate Enable/Disable Delay

t_{PGE}	Output Gate Enable Crossing V_{THI} to Qn/Qn Crosspoint	—	—	3.5	ns
t_{PGD}	Output Gate Disable Crossing V_{THI} to Qn/Qn Crosspoint Driven to GL Designated Level	—	—	3.5	ns

Power Down Timing

t_{PWRDN}	PD Crossing V_{THI} to Qn = V_{DD} , Qn = V_{DD}	—	—	100	μ S
t_{PWRUP}	Output Gate Disable Crossing V_{THI} to Qn/Qn Driven to GL Designated Level	—	—	100	μ S

RMS Additive Phase Jitter

t_{JIT}	RMS Additive Phase Jitter @ 25MHz (12kHz – 10MHz Integration Range)		0.541		ps
	RMS Additive Phase Jitter @ 125MHz (12kHz – 20MHz Integration Range)		0.159		ps
	RMS Additive Phase Jitter @ 156.25MHz (12kHz – 20MHz Integration Range)		0.185		ps

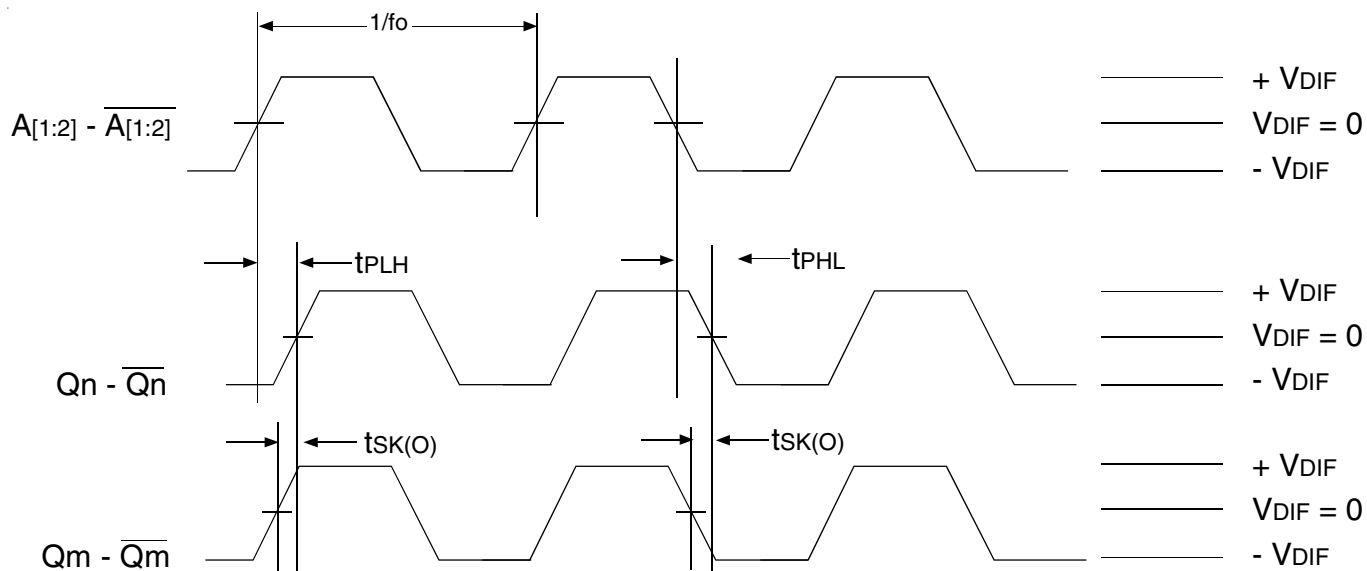
Output Rise/Fall Time

t_r/t_f	Output Rise/Fall Time ⁽⁶⁾ , (20% - 80%)	125		600	ps
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NOTES:

1. AC propagation measurements should not be taken within the first 100 cycles of startup.
2. Skew measured between crosspoints of all differential output pairs under identical input and output interfaces, transitions and load conditions on any one device.
3. Skew measured is the difference between propagation delay times t_{PHL} and t_{PLH} of any differential output pair under identical input and output interfaces, transitions and load conditions on any one device.
4. Skew measured is the magnitude of the difference in propagation times between any single differential output pair of two devices, given identical transitions and load conditions at identical V_{DD} levels and temperature.
5. All parameters are tested with a 50% input duty cycle.
6. Guaranteed by design but not production tested.

DIFFERENTIAL AC TIMING WAVEFORMS

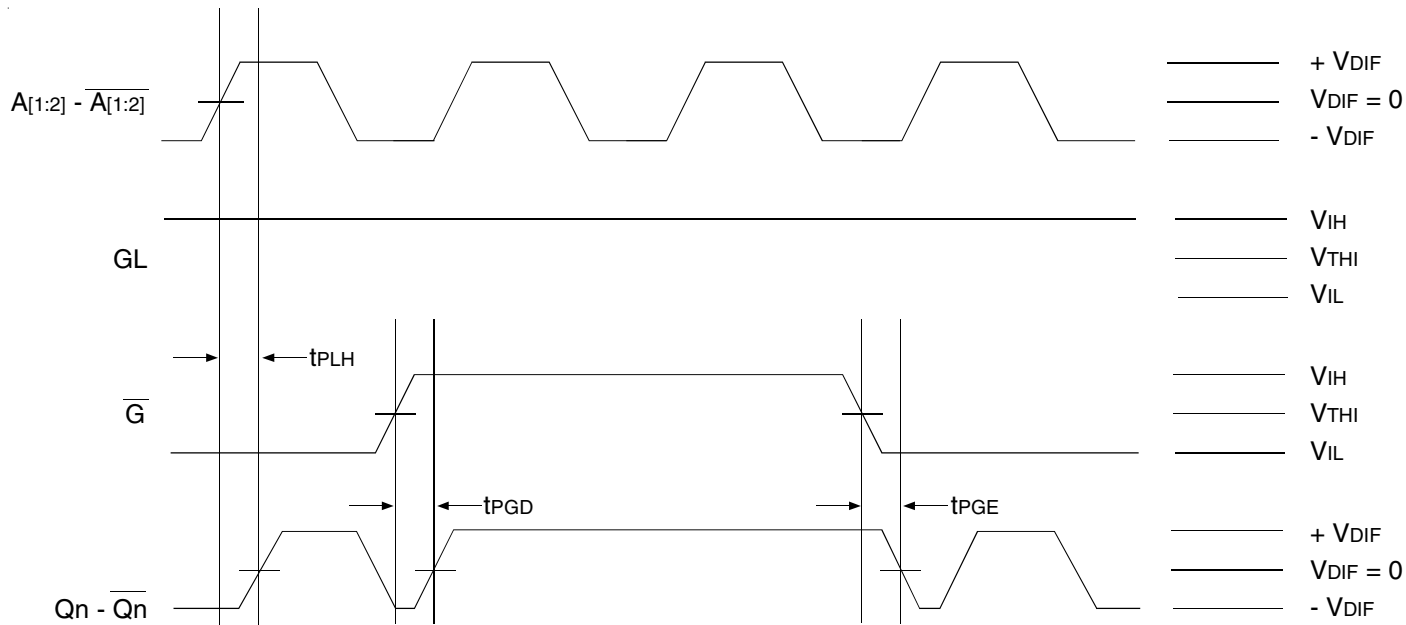
*Output Propagation and Skew Waveforms***NOTES:**

1. Pulse skew is calculated using the following expression:

$$t_{SK(P)} = |t_{PHL} - t_{PLH}|$$

Note that the t_{PHL} and t_{PLH} shown above are not valid measurements for this calculation because they are not taken from the same pulse.

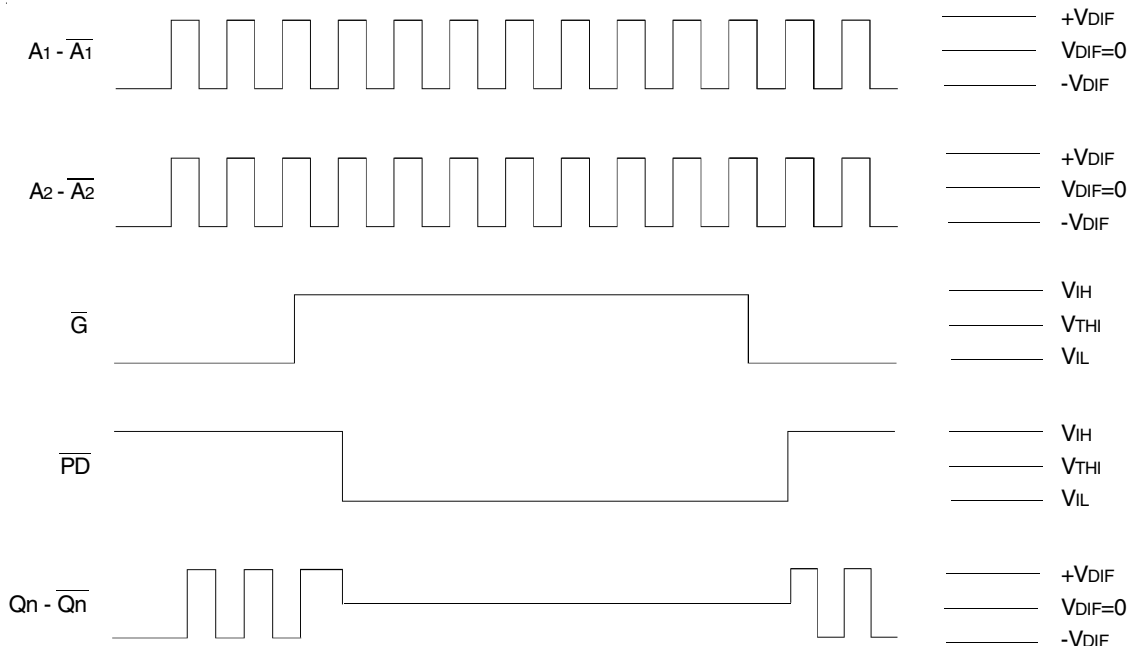
2. AC propagation measurements should not be taken within the first 100 cycles of startup.



Differential Gate Disable/Enable Showing Runt Pulse Generation

NOTE:

- As shown, it is possible to generate runt pulses on gate disable and enable of the outputs. It is the user's responsibility to time the G signal to avoid this problem.

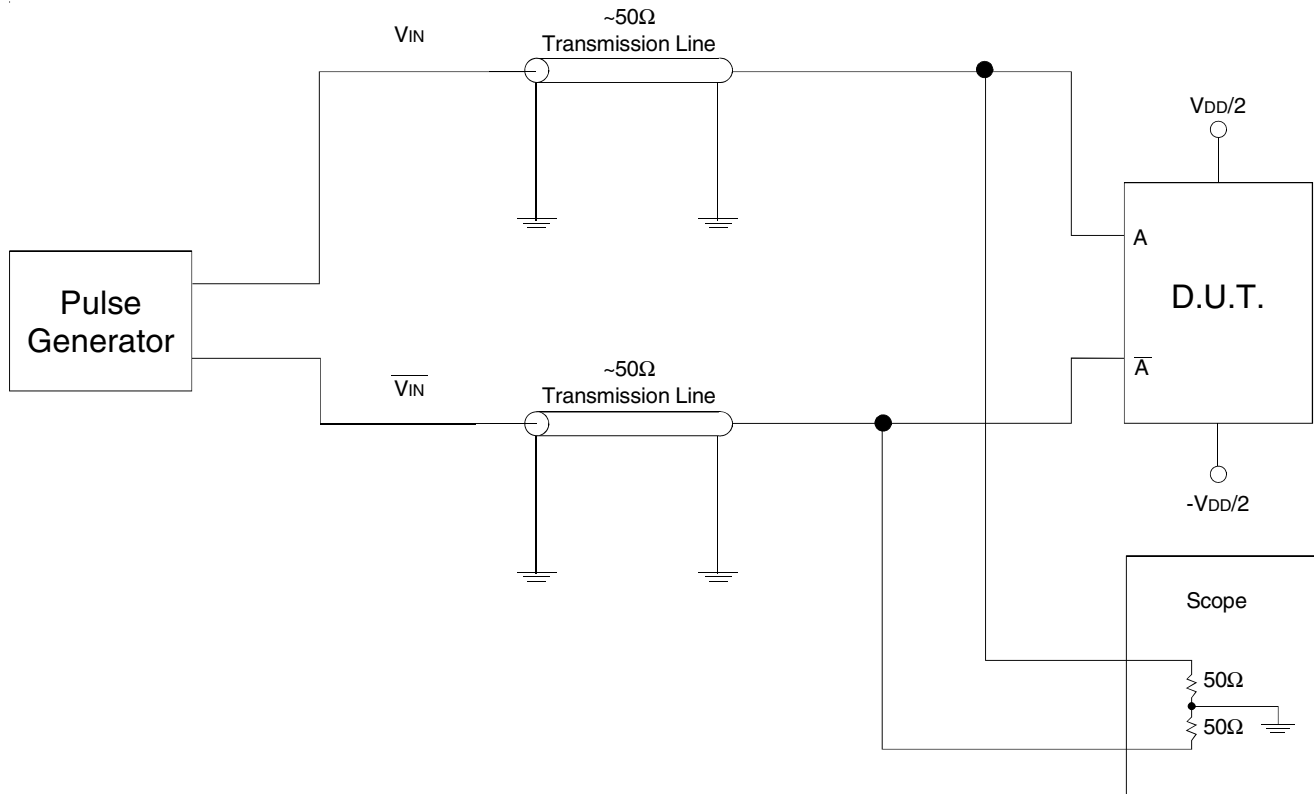


Power Down Timing

NOTES:

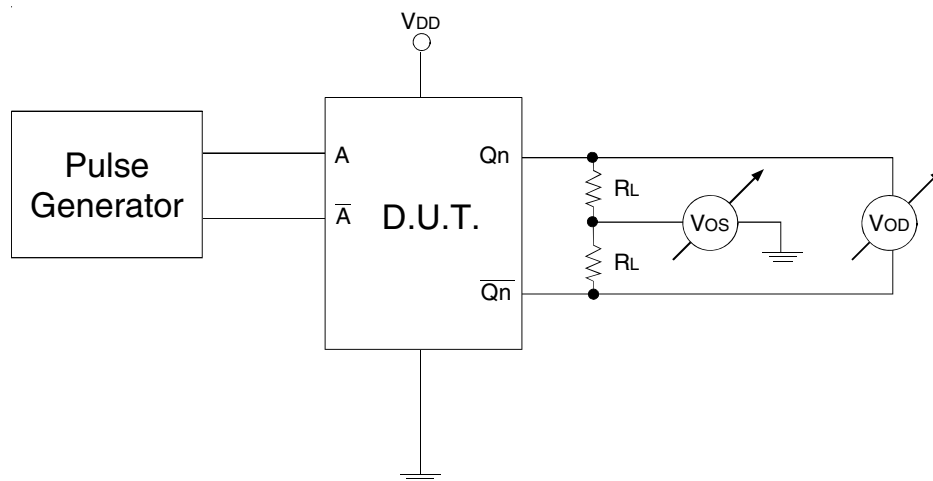
- It is recommended that outputs be disabled before entering power-down mode. It is also recommended that the outputs remain disabled until the device completes power-up after asserting $\overline{PD}$.
- The POWER DOWN TIMING diagram assumes that GL is HIGH.
- It should be noted that during power-down mode, the outputs are both pulled to V_{DD} . In the POWER DOWN TIMING diagram this is shown when $Qn - \overline{Qn}$ goes to $V_{DIF} = 0$.

TEST CIRCUITS AND CONDITIONS

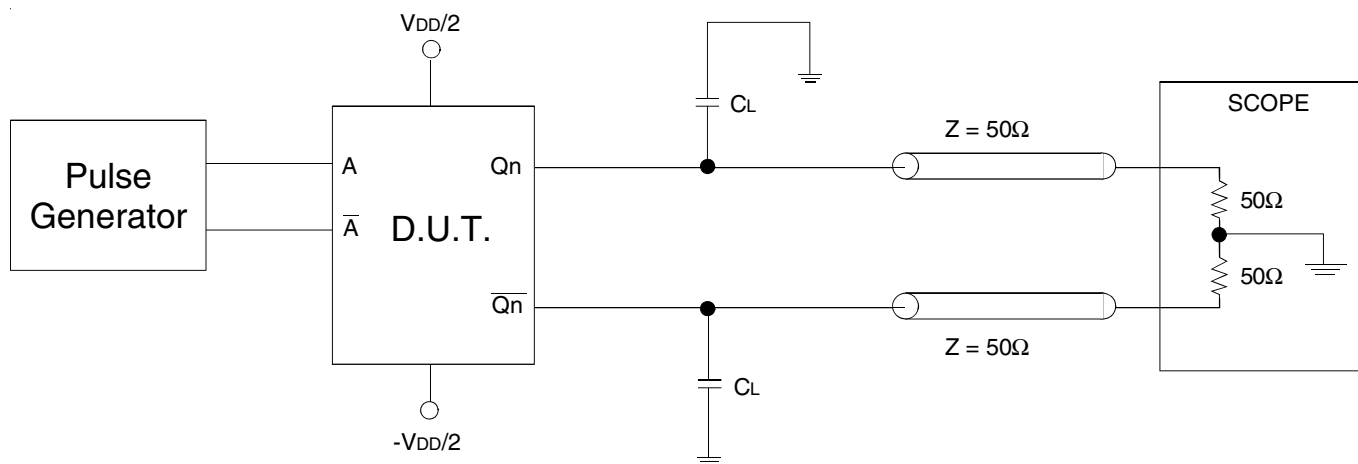
*Test Circuit for Differential Input*

DIFFERENTIAL INPUT TEST CONDITIONS

Symbol	$V_{DD} = 2.5V \pm 0.2V$	Unit
V_{THI}	Crossing of A and $\overline{A}$	V



Test Circuit for DC Outputs and Power Down Tests



Test Circuit for Propagation, Skew, and Gate Enable/Disable Timing

LVDS OUTPUT TEST CONDITION

Symbol	$V_{DD} = 2.5V \pm 0.2V$	Unit
C_L	0 ⁽¹⁾	pF
	8 ^(1,2)	
R_L	50	Ω

NOTES:

- Specifications only apply to "Normal Operations" test condition. The T1A/E1A specification load is for reference only.
- The scope inputs are assumed to have a 2pF load to ground. T1A/E1A - 644 specifies 5pF between the output pair. With $C_L = 8pF$, this gives the test circuit appropriate 5pF equivalent load.



July 23, 2002	Datasheet creation
October 8, 2002	Page 1, entire page changed; page 2, both diagrams; page 3, Pin Description and notes; page 4, DC Cha. for LVPECL and Differential Input tables; page 6, DC Cha. and Power Supply tables; page 7, entire page; page 9, added note 3; page 10, entire page; page 10, entire page; page 11, entire page; page 12, Ordering Info; added 3 new pages (10 thru 12) of diagrams.
October 10, 2002	Page 1, entire page changed; page 2, both diagrams; page 3, Pin Description and notes; page 7, AC Cha. table; page 8, added new LVPECL table; page 10, removed Input Clock Switching diagram; page 11, deleted entire page; page 12, changed Power Down Timing; page 15, Ordering Info.
October 24, 2002	Page 2, added note 1 to TQFP TOP VIEW text; page 3, added note 4 to Pin Description; page 4, replaced "Compliant devices must meet" with the text "This device meets" in four instances; page 5, Differential Input table, note 1, changed 1V to 732mV and replaced "Compliant devices must meet" with the text "This device meets"; page 6, DC Electrical table, Vdif row, changed Min. value to 0.1, and under Differential Input table replaced "Compliant devices must meet" with the text "This device meets" page 7, Power Supply table, replaced ((TBD)) with 800MHz, and under AC Electrical table, replaced ((TBD)) with 500; page 8, completely altered AC Differential table; page 12, LVDS Output table, replaced ((TBD)) with 3.
November 1, 2002	Radical changes to entire document.
December 12, 2002	Radical changes to entire document, using 5T9316 as a base.
December 16, 2002	Throughout document, removed "Differential" from title; page 7, Power Supply table, changed Max values, changed REFERENCE value; page 10, note 1, changed Gx to G.
May 8, 2003	Page 2, corrected pinout diagram.
August 7, 2003	Page 1, Features text, 3rd bullet, changed 2ns to 1.75ns, 4th bullet, changed 800MHz to 1GHz, and 7th bullet, added CML, on Description, 3rd line, added CML to list; page 4, Pin Descr., note 1, added "Differential CML levels", for Description of PD row, replaced 2nd sentence with "Both 'true' and 'complementary' output will pull to Vdd"; page 5, DC... for Differential Inputs table, removed note 5 and changed Vcm Max. from 3.5 to Vdd; page 7, Power Supply table, changed 800MHz to 1GHz; page 8, AC Differential table, changed Vix and Vcm Max specs from 3.5V to Vdd, removed notes 4 and 5, and placed entire table on page 7, for AC Elect. table, added notes 5 and 6, changed ((TBD)) to 300ps, tplh Type to 1.25ns, and Max from 2ns to 1.75ns, and changed fo Max from 800MHz to 1GHz.
October 2, 2003	Page 1, Features, 7th bullet, added "3.3V / 2.5V LVTTTL" to front, Description, added to 1st paragraph "A single-ended 3.3V / 2.5V LVTTTL input can also be used to translate to LVDS outputs."; page 4, Pin Description table, added large block of text to 2nd row, added "Single-ended 3.3V and 2.5V LVTTTL levels" to note 1; page 5, DC for LVTTTL table, added Vref row and note 3, for DC for LVDS table, changed Ios ratings from 5 Typ, 7.5 Max to 12 Typ, 24 Max, and changed Iosd ratings from 5 Typ, 7.5 Max to 6 Typ, 12 Max; page 7, Power Supply table, changed Ipd from 3 to 5.
March 26, 2004	Page 2, changed pin 22 to NC; page 3, changed pin 25 to NC; page 4, added NC row to Pin Description.
June 22, 2004	Removed TQFP package.
October 26, 2004	Inserted a page before Ordering Info and added Landing Pattern.
October 27, 2004	Added note to Landing Pattern.
October 29, 2004	Changed landing pattern diagram.
March 9, 2005	Page 6, switched Iddq and Itot values.
October 23, 2007	Page 7, added Additive Phase Jitter, RMS specs to the AC Electrical Characteristics Table.
April 15, 2008	Page 7, added Rise/Fall Time spec. to the AC Electrical Characteristics Table.

ORDERING INFORMATION

IDT	XXXXX	XX	X		
Device Type	Package	Process			
			I		-40°C to +85°C (Industrial)
			NL		Thermally Enhanced Plastic Very Fine Pitch Quad Flat No Lead Package
			5T9306		2.5V 1:6 LVDS Clock Buffer Terabuffer™ II

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